

DESCRIPTION

PHOSPHOR SINGLE CRYSTAL SUBSTRATE AND METHOD FOR PREPARING
THE SAME, AND NITRIDE SEMICONDUCTOR DEVICE USING THE SAME

5 Technical Field

The present invention relates to a phosphor bulk single crystal substrate formed by crystallization from supercritical solution and a method for preparing the same, and a light emitting device using the substrate.

10

Background Art

To realize the white light emitting from blue light emitting by converting a wavelength from a nitride semiconductor light emitting device, a device of combination with a gallium nitride light emitting device and YAG:Ce phosphor is proposed. The mechanism for obtaining the white light from emitting device of converting a wavelength generally comprises steps of mixing phosphor powder into coating of LED chip or mold resin, absorbing a part of the emitted light from the chip into the phosphor, exciting a phosphor, mixing the excited light from the phosphor with the emitted light from the chip which is not absorbed, and forming a mixed colored light.

However, the method for manufacturing the phosphor layer using the phosphor mixed with the coating or mold

resin has some problems: the degree of dispersion of the phosphor in the resin is varied by descending the phosphor during a process of solidifying the resin, uniform mixed color cannot be obtained, and the yield is very low.

5 To overcome aforementioned problems, it was attempted that the gallium nitride semiconductor layer was formed directly on the substrate obtained by YAG single crystal to obtain a uniform phosphor layer, but it was found that it was difficult to carry out the vapor phase growth of the
10 gallium nitride crystal on the YAG crystal through the buffer layer.

Disclosure of Invention

The object of the present invention is to provide a
15 phosphor single crystal substrate in which a gallium nitride crystal can be grown in the vapor phase and also provide a light emitting device of converting wavelength in high yield, which could not be obtained by the powdered phosphor.

20 The inventors of the present invention found the method for obtaining the nitride bulk single crystal by recrystallizing from supercritical ammonia-containing solution. (as shown Japanese Patent Application No. 2002-143449) On the other hand, a phosphor in the form of GaN
25 doped with Zn or Cd is disclosed in Japanese Patent Laid-

Open Publication No. 51-41686. In this procedure the nitride reaction of gallium oxide occurred indeed on a surface of grains, however there are a lot of problems with reaching a 100% yield. Additionally, the phosphor produced
5 has a low crystalline quality and a low spectral reflectance. When the phosphor is excited with UV rays or the electron beams, the phosphor can emit light of unsatisfactory properties and it would be hard to use such a phosphor in, for example, a fluorescent display.
10 However, the inventors of the present invention found that when ammonia reacts with metallic gallium or other elements of the Group XIII (IUPAC 1989) in the presence of alkali metal or its compounds and the nitride phosphor can be prepared by crystallization from supercritical ammonia-
15 containing solution, the synthesis reaction of nitride, for example GaN, can be accelerated, which makes it possible for the obtained nitride phosphor to have a uniform composition, a high spectral reflectance and a good crystalline quality, and also which makes it possible for
20 obtained nitride phosphor to emit the light effectively when excited with the UV rays or electron beams, which means the phosphor is useful for devices such as fluorescent displays.

25 Examples

A crucible made of the nickel alloy of an inner diameter of 10 mm is charged with 1 g of metallic gallium and 0.1 g of metallic Zn, followed by introducing the crucible into a high-pressure autoclave of an inner 5 diameter 14 mm and a height of 70 mm. The autoclave is charged then in a dry glove box with LiNH₂, sealed and evacuated of gases with a special system, and 4.9 g of ammonia is dropped into the reaction chamber. After re-sealing, the autoclave is placed in a furnace and heated to 10 550°C, with the pressure in the autoclave reaching about 4000 bar. The autoclave is allowed to stay in these conditions for 1 week, then the temperature is lowered to the room temperature, and consequently the pressure in the autoclave is lowered to about 10 bar. After evacuation of 15 ammonia the autoclave is placed inside a dry glove box and the crucible removed. The crucible contents are washed with water, to allow hydrolysis and washing off LiNH₂ in the form of well water-soluble LiOH. The solid residues from the crucible are dried and resulted in a phosphor of GaN:Zn 20 type in the form of a white powder. Photographs of the phosphor taken by a field emission scanning electron microscope (25000x magnitude) illustrate many crystallites of the shape of hexagonal prism, indicating a good crystalline quality of the phosphor.

The obtained phosphor is illuminated with the UV rays of the wavelength of 365 nm, followed by measuring its luminescence spectrum. The measurement results are shown in Fig. 7. The same phosphor is also placed in the electron beams of the voltage of 7 kV and the current density of 0.5 $\mu\text{A}/\text{cm}^2$, and the results of cathodoluminescence measurements are shown in Fig. 8. Both plots show that the obtained phosphor may be efficiently excited with UV rays or electron beams and can emit the blue light. The emission luminance acquired by exciting the phosphor of the invention with UV rays or electron beams reached accordingly 156% and 160% of the emission luminance of the GaN:Zn phosphor produced according the process as described in Japanese Patent Laid-Open Publication No. 51-41686. This means that the significant enhancement of the emission properties of the phosphor is achieved.

The obtained phosphor is also analyzed by an X-ray diffraction with an X-ray powder diffractometer. The recorded diffractograms are shown in Fig. 9. The diffractograms revealed that phosphor has the crystal structure of a wurtzite, belonging to hexagonal system. For the lattice constants, the a-axis length is 3.189 angstroms, and the c-axis length is 5.185 angstroms. Further, based on Scherrer equation, the diameter of crystallites in the (102) direction is calculated. The

diameter of crystallites of the phosphor GaN:Zn produced according to the process of Japanese Patent Laid-Open Publication No. 51-41686 is 285 angstroms, whilst the diameter of crystallites of the phosphor of the invention 5 is 857 angstroms. For wavelengths in the range of 380 nm to 730 nm a spectral reflectance of the produced phosphor is also measured. The results are shown in Fig. 10, where the measurement is relative in character, i.e. made under the assumption that a spectral reflectance of a typical 10 standard - a white barium sulphate - is 100%. Fig. 10 shows that the color of the phosphor of the invention is white and that a spectral reflectance is not less than 70% in a range of wavelengths of 430 nm to 730 nm. Since the phosphor of the invention has a high spectral reflectance 15 and a light absorption thereof is small, it can emit light efficiently.

Accordingly, the object of the present invention is to provide a nitride phosphor bulk single crystal by crystallization from supercritical ammonia-containing 20 solution and to provide a light emitting device of converting wavelength having good yield by using the phosphor as a substrate.

The phosphor substrate bulk single crystal is a nitride having a general formula XN , $XN:Y$ or $XN:Y,Z$, 25 wherein X is at least one element selected from B, Al, Ga

and In, Y is at least one element selected from Be, Mg, Ca, Sr, Ba, Zn, Cd and Hg, and Z is at least one element selected from C, Si, Ge, Sn, Pb, O and S.

The present invention is based on the reaction between ammonia and the element of Group XIII or a compound thereof at a temperature not lower than 132°C and under a pressure not less than 112 bar in the presence of at least one element selected from Group I and Group II and/or compounds thereof, such as hydrides, imides, amides and nitrides.

When a metal or its compound including at least one element selected from B, Al, Ga or In reacts with NH₃ in conditions above its critical point (132°C, 112 bar), the nitride reaction essentially takes place, but its rate is not satisfactory. However, when the reaction environment is supplemented with at least one element selected from Group I and Group II (IUPAC 1989) and/or compounds thereof, such as hydrides, imides, amides and nitrides, the nitriding reaction becomes much faster and efficient. The Group I element may preferably be Li, Na or K, while the Group II element may preferably be Mg or Ca. Nitrides of the Group I elements may preferably include Li₃N, Na₃N, K₃N, their amides may include LiNH₂, NaNH₂ and KNH₂, and imides - Li₂NH etc. Nitrides of the Group II elements may preferably include Mg₃N₂, Ca₃N₂, their amides may include Mg(NH₂)₂, Ca(NH₂)₂, and imides - CaNH etc. Thanks to the native

nitrogen defects the nitride phosphor obtained according to the invention can emit light even when it is not intentionally doped.

In case of the light emission by a donor-acceptor pair, when the donor comprises a spontaneously originating nitrogen defect, acceptors may be preferably produced with the Group II and Group XII elements, such as Be, Mg, Ca, Sr, Zn, Cd or Hg.

It is preferable to use the reaction between NH₃ and at least one co-activator element selected from Group XIV and Group XVI (IUPAC 1989), such as C, Si, Ge, Sn, Pb, O, S and/or compounds thereof.

In case of the light emission by a donor-acceptor pair, donors may be preferably produced with the elements selected from C, Si, Ge, Sn, Pb, O and S, and acceptors may be preferably produced with the elements selected from Be, Mg, Ca, Sr, Zn, Cd and Hg.

The process for obtaining a phosphor bulk single crystal is based on a technique of an ammono-basic growth of a crystal which comprises a chemical transport in a supercritical ammonia-containing solvent containing at least one mineralizer for imparting an ammono-basic property, to grow a nitride single crystal. In this technique, the impurities such as Zn or Cd with feedstock are dissolved in the supercritical solvent and then the

obtained crystal is recrystallized on the nitride seed having the optional main plane.

In this regard, the seed enables selective growth of a phosphor substrate.

5 In the technique of an ammono-basic growth of a crystal, it is found that the crystal growth may be influenced by the composition and concentration of the supercritical ammonia-containing solution, the temperature difference between the dissolution zone and the
10 crystallization zone, the location and area of the baffle by which a convection flow rate is controlled basing on the temperature difference, the filling ratio of ammonia and the ratio of surface area of the seed with respect to that of the feedstock etc. Furthermore, according to the present
15 invention, a convection flow rate of the supercritical solution between dissolution zone 13 and crystallization zone 14 can be determined by the convection control means 2 and the temperature difference, therefore nitride crystal can be selectively grown on the seed by maintaining
20 supersaturation of the supercritical solution with respect to the seed and controlling below a certain concentration so as not to allow spontaneous crystallization.

Moreover, supercritical ammonia-containing solution containing alkali metal ions has an excellent solubility, thereby it is possible to decrease an contamination by
25

impurities from the autoclave inner wall if a lining of metal such as Ag, Mo, Fe or Ta, or alloy thereof is applied to the inner wall of the autoclave.

The convection control means is used to create a temperature gradient between the dissolution zone and the crystallization zone, and the form and area of the convection control means can be varied by the volume of the autoclave and the ratio of inside diameter to the total length of the autoclave. It is preferable that the convection control means may be formed within the range of 70% to 90% of the inner cross-sectional area of the autoclave and the ratio of opening in baffle may be set at 30% or less. The location of baffle may be adjusted in accordance with the quantity of the grown crystal and the baffle may be located within the range from 1/3 to 2/3 of the total length of the inner chamber of the autoclave, thereby to adjust the ratio between the dissolution zone and the crystallization zone to a desired value. It is preferable that the feedstock is placed in the dissolution zone and the filling ratio of the feedstock is less than half of the dissolution zone. In case that the feedstock is in the form of gallium metal, the filling ratio of the feedstock may be about 1/4 of the dissolution zone, because the volume of the feedstock will be increased by transforming from gallium metal to poly-GaN in the crucible.

In the area of the convection control means 2, it is preferable that the cooling device 6 is arranged for cooling so that it is easier to make a predetermined temperature difference between the dissolution zone 13 and 5 the crystallization 14. It is also preferable that the cooling device 18, which can cool the bottom of the flowing area of the crystallization zone, is placed in the autoclave and thereby rapid cooling function is executed after crystallization.

10 Using the above-specified constitution of the autoclave, it is possible to improve the growth rate on a seed. It is preferable that the ratio of diameter to total length of the autoclave may be set from 1/15 to 1/3, the ratio of opening in the horizontal baffle on the cross-15 sectional area may be set at 30% or less and growth rate on a seed may be 10 $\mu\text{m}/\text{hr}$ or more.

Brief Description of Drawings

Fig. 1 shows a relation between pressure and GaN 20 solubility in the supercritical ammonia containing potassium amide (at molar ratio of $\text{KNH}_2:\text{NH}_3=0,07$) at $T=400^\circ\text{C}$ and $T=500^\circ\text{C}$.

Fig. 2 shows a graph illustrating a relation of change 25 in temperature in an autoclave with the passage of time and change between a dissolution step and a crystallization

step, where the pressure is kept constant.

Fig. 3 shows a graph illustrating a relation of change in pressure in an autoclave with the passage of time and change between a dissolution step and a crystallization 5 step, where the temperature is kept constant.

Fig. 4 is a schematic cross-sectional view of an autoclave and a furnace unit used in this invention.

Fig. 5 is a schematic perspective view of an apparatus for obtaining a nitride bulk single crystal.

10 Fig. 6 shows a graph illustrating change in temperature in an autoclave with the passage of time and a relation of change in a dissolution step and a crystallization step in Example.

15 Fig. 7 shows the photoluminescence spectrum of the phosphor prepared by crystallization from supercritical ammonia-containing solution after excitation with UV rays.

Fig. 8 shows the cathodoluminescence spectrum of the phosphor prepared by crystallization from supercritical ammonia-containing solution after excitation with electron 20 beams.

Fig. 9 shows the X-ray diffractogram of the phosphor prepared by crystallization from supercritical ammonia-containing solution.

25 Fig. 10 shows the curve of the spectral reflectance of the phosphor prepared by the supercritical method.

Fig. 11 is a schematic cross-sectional view of the first light emitting device formed on the phosphor substrate according to the present invention.

5 Fig. 12 is a schematic cross-sectional view of the second light emitting device formed on the phosphor substrate according to the present invention.

Best Mode for Carrying Out the Invention

The apparatus for obtaining a bulk single crystal 10 comprises an autoclave 1 for preparing a supercritical solvent equipped with a convection control means 2 for establishing a convection flow, and at least one furnace unit 4 equipped with a heating device 5 and a cooling device 6 on the autoclave. The furnace unit includes a 15 higher temperature zone 14 equipped with a heating device 4, which corresponds to a crystallization zone in the autoclave, and a lower temperature zone 13 equipped with a heating device which corresponds to a dissolution zone in the autoclave. It is also possible to use a furnace unit 20 which includes a higher temperature zone equipped with a heating device, and/or cooling device, and a lower temperature zone equipped with a heating device and/or cooling device. The convection control means for establishing a convection flow is composed of at least one 25 horizontal baffle having a central opening and/or a

periphery space so as to devide the crystallization zone from the dissolution zone. Thus, the feedstock is set in the dissolution zone, and the seed is set in the crystallization zone, in the autoclave. The convection flow of the supercritical solution between the dissolution zone and the crystallization zone is controlled by the convection control means. The dissolution zone is located above the horizontal baffle, and the crystallization zone is located below the horizontal baffle.

The apparatus for obtaining a bulk single crystal according to the present invention is illustrated in Fig.4 and Fig.5. The main part of the apparatus comprises the autoclave 1 used for preparing a supercritical solvent and the convection control means 2 which enhances chemical transport in the supercritical solution within the autoclave 1. The autoclave 1 is situated in the chamber 3 of the furnace unit 4 (2 sets), equipped with the heating device 5 and the cooling device 6. The autoclave 1 within the furnace unit 4 is secured by a screw blocking device 7. The furnace 4 is embedded in the bed 8 and secured with steel tapes 9 tightly wound around the furnace unit 4 and the bed 8. The bed 8 with the furnace unit 4 is pivotally mounted on the turntable 10 and secured in the desired position by means of a pin securing device 11, so that the convective form and convection flow in the autoclave can be

controlled. The convection flow of the supercritical solution in the autoclave 1 placed in the furnace unit 4 is established by means of the convection control means 2, which is composed of the horizontal baffle 12 of a size 5 corresponding to about 70 % of horizontal cross-sectional area of the autoclave 1, dividing the crystallization zone from the dissolution zone. The horizontal baffle 12 is located approximately in the middle of the autoclave 1 in terms of longitudinal dimension. Temperature values in each 10 zone of the autoclave 1, falling within the range from 100°C to 800°C, are controlled by a control unit 15 placed near the furnace unit 4. In the autoclave 1 the dissolution zone 13 corresponding to the lower temperature zone of the furnace unit 4 is situated above the horizontal baffle 12. 15 The feedstock 16 is placed in the dissolution zone 13 and the amount of the feedstock 16 is such that its volume does not exceed 1/2 of volume of the dissolution zone. Simultaneously, when metallic gallium is introduced as a feedstock in crucible, the total volume of the crucible 20 should not exceed 1/2 of volume of the dissolution zone. The crystallization zone 14 corresponding to higher temperature zone of the furnace unit 4 is situated below the horizontal baffle 12. In the crystallization zone 14 the seed 17 is located and the specific position in which 25 the seed 17 is placed is below crossing of up-stream

convection flow and down-stream convection flow, but still above the bottom of the crystallization zone. The cooling device 6-1 for cooling is placed within the zone of the convection control means 2. As the result, the 5 predetermined temperature difference between the dissolution zone 13 and the crystallization zone 14 may be controlled. At the level of the bottom of the crystallization zone there is another cooling device 6-2, used in order to cool down the zone after the crystallizing 10 process is over, so that the dissolution of the grown crystal during the cooling stage after the crystallizing process can be remarkably prevented.

According to the result of the research, GaN exhibits good solubility in NH₃ including alkali metals or their 15 compounds, such as KNH₂. The graph in Fig.1 presents how solubility of GaN in supercritical solvent depends on pressure, for temperature 400°C and 500°C. Here the solubility is defined as the molar percentage: S_m ≡ [GaN^{solution} : (KNH₂ + NH₃)] × 100%. In this case, the solvent 20 is the supercritical ammonia-containing solution in which the molar ratio X ≡ KNH₂ : NH₃ is set at 0.07. Solubility S_m may be a function of three parameters: temperature, pressure, and molar ratio of the mineralizer, i.e. S_m ≡ S_m(T, p, x). Small changes of ΔS_m can be expressed as:
25
$$\Delta S_m \approx (\partial S_m / \partial T)_{p,x} \Delta T + (\partial S_m / \partial p)_{T,x} \Delta P + (\partial S_m / \partial x)_{T,x} \Delta x,$$

where the parameters in the partial derivatives, e.g. each coefficient of $(\partial S_m / \partial T)_{p,x}$ and so on, is defined as a temperature coefficient of the solubility and a pressure of the solubility, and a molar ratio coefficient of the mineralizer.

As it results from the above graph presented in Fig.1, the solubility of the nitride in the supercritical ammonia-containing solution is an increasing function of pressure and a decreasing function of temperature. On the basis of these dependences it is possible to obtain GaN bulk single crystal by dissolving it under higher solubility conditions and crystallizing under lower solubility conditions. Negative temperature coefficient of solubility means that in the presence of a temperature gradient the chemical transport of nitride occurs from the lower temperature dissolution zone to the higher temperature crystallization zone. Furthermore, it is also found that other gallium compounds and metallic gallium can be used as a supplier for GaN complex.

For example, Ga complex, such as metallic gallium which is the simplest element can be introduced into the above solvent. Next, the supersaturation of solution with respect to nitride is obtained by change of physical conditions such as heating, so that crystal can be grown on a seed. According to the present invention, it is possible

to crystallize the desired nitride bulk single crystal on a seed and also to lead the stoichiometric growth of GaN obtained as a bulk single crystal layer on a seed in the form of GaN crystal.

5 The obtained single crystal may contain alkali metals at the concentration of 0.1 ppm or more since the single crystal is grown in the supercritical ammonia-containing solution containing alkali metal ions. In view of maintaining the desired ammono-basic character of the
10 supercritical solution, and also in order to avoid corrosion of the apparatus, no halogens are intentionally introduced into the supercritical solvent. According to the present invention, intentional replacing of 0.001 to 0.50 Ga by Al or In may be achieved. The crystal lattice
15 constants of the obtained nitride can be adjusted by an appropriate modification of the composition. GaN bulk single crystal obtained by the process according to the present invention may be also intentionally doped with donor dopants (such as C, Si, Ge, Sn, Pb, O or S etc.),
20 acceptor dopants (such as Be, Mg, Ca, Sr, Zn, Cd, Hg etc.) or magnetic dopants (such as Mn, Cr etc.) in concentrations of 10^{17} to $10^{21}/\text{cm}^3$. The dopants change optical, electrical and magnetic properties of nitride. As for other physical properties, the grown GaN bulk single crystal has a surface
25 dislocation density of $10^6/\text{cm}^2$ or less, preferably $10^5/\text{cm}^2$

or less, more preferably $10^4/\text{cm}^2$ or less, and also has the full width at half maximum of the X-ray from the surface (0002) plane of 600 arcsec. or less., preferably 300 arcsec. or less, more preferably 60 arcsec. or less. It is
5 possible to grow a GaN bulk single crystal as the best which has a surface dislocation density of about $10^4/\text{cm}^2$ or less, and the full width at half maximum of the X-ray from the surface (0002) of 60 arcsec. or less.

(Temperature difference between the crystallization
10 zone and the dissolution zone)

When two zones, i.e., the dissolution zone and the crystallization zone are simultaneously formed in the autoclave, supersaturation of the supercritical solution with respect to the seed is maintained by controlling the
15 dissolution temperature and the crystallization temperature. The control is found to be easy by setting the temperature of the crystallization zone at 400 to 600°C, and by maintaining the difference in temperature between the dissolution zone and the crystallization zone within the
20 autoclave, at 150°C or less, preferably 100°C or less. Preferably, the adjustment of the supersaturation of the supercritical solution with respect to the seed is made by providing at least one baffle for dividing the internal of the autoclave into a lower temperature dissolution zone and
25 a higher temperature crystallization zone, and controlling

the convection flow between the dissolution zone and the crystallization zone. Further, when two zones, i.e., a dissolution zone and a crystallization zone, between which a specified temperature difference is set, are formed in
5 the autoclave, the supersaturation of the supercritical solution with respect to the seed is preferably adjusted by using a feedstock having a total surface area larger than the total surface area of the seed.

The present invention relates to a technique of an
10 ammono-basic growth of a crystal which comprises the steps of causing a chemical transport in a supercritical ammonia-containing solvent containing at least one mineralizer for imparting an ammono-basic property, thereby growing a nitride single crystal. The terms herein shoud be
15 understood as having the meanings defined as below in the present specification.

(Nitride)

"Nitride phosphor substrate" in the specification is a compound which includes at least nitrogen atom as a
20 consistent element. The phosphor substrate comprises a nitride having a general formula XN , $XN:Y$ or $XN:Y,Z$, wherein X is at least one element selected from B, Al, Ga and In, Y is at least one element selected from Be, Mg, Ca, Sr, Ba, Zn, Cd and Hg, and Z is at least one element
25 selected from C, Si, Ge, Sn, Pb, O and S. Moreover the XN

can be defined as the general formula $\text{Al}_x\text{Ga}_{1-x-y}\text{In}_y\text{N}$, where
5 $0 \leq x \leq 1$, $0 \leq y \leq 1$, and $0 \leq x+y \leq 1$, and may contain at least the
binary compound such as GaN or AlN, ternary compounds such
as AlGaN, InGaN or also quaternary compound AlInGaN. The
term "nitride phosphor substrate" means a nitride single
crystal substrate which can produce a new light source from
converting the luminescence wavelength from LED or LD by
combining the substrate with a light emitting device such
as LED or LD formed by an epitaxial growing process, for
10 example MOCVD, HVPE or the like.

(Precursor)

The term "a precursor of nitride" means a substance which
can be selected from B, Al, Ga or In, and if needed, an
alkali metal, an element of the Group XIII, nitrogen and/or
15 hydrogen, or a mixture thereof, and examples of such a
precursor include metal, an alloy or an intermetallic
compound thereof, and a hydride, amide, imide, amido-imide
or azide thereof, which can form a nitride soluble in a
supercritical ammonia-containing solvent as defined below.

20 (Feedstock)

The term "feedstock" means a purposed nitride or a
precursor thereof. The process of the present invention is
based on an ammono-basic reaction. The feedstock may be
GaN or AlN formed by HVPE, or GaN or AlN formed by chemical
25 reactions, which originally may contain chlorine, in so far

as the ammono-basic supercritical reaction is not hindered. A combination of nitride which is dissolved in an equilibrium reaction to the supercritical ammonia-containing solvent and metallic gallium or metallic aluminum which irreversibly reacts with the supercritical ammonia-containing solvent can be used as a feedstock.

The control of the reaction for crystallization becomes easy by making use of gallium nitride as the nitride. In this case, the same nitride single crystal is preferably used as a seed. GaN obtained by flux method or vapor phase method such as HVPE method, or polycrystalline gallium nitride poly-crystallized from supercritical ammonia or metallic Ga can be used as a feedstock for GaN.

(Supercritical ammonia-containing solvent)

In the present invention the supercritical solvent may contain NH₃ or a derivative thereof. The mineralizer may contain alkali metal ions, at least, ions of sodium or potassium. The term "supercritical ammonia-containing solvent" means a supercritical solvent which may contain at least ammonia, and ion or ions of at least one alkali metal for dissolving nitride and further preferably alkali earth metal.

(Mineralizer)

The term "mineralizer" means a supplier for supplying one or more of alkali metal ions for dissolving nitride in

the supercritical ammonia-containing solvent. Mineralizer is introduced in the form of alkali metal compound for imparting alkali metal or alkali metal ions in the supercritical ammonia-containing solvent. In the view of 5 the purity, it is preferable that the mineralizer in the form of alkali metallic azide (NaN_3 , KN_3 , LiN_3 , CsN_3), alkali metal amide (LiNH_2 , KNH_2 , NaNH_2 , CsNH_2), alkali metallic imide (Li_2NH , K_2NH , Na_2NH , Cs_2NH) alkali metal (Na, K, Li, Cs), alkali metallic hydride (LiH , KH , NaH , CsH) or 10 other compound such as Li_3N , K_3N , Na_3N , Cs_3N etc. may be introduced, however, the alkali metal and alkali metallic compound can be simultaneously used, as required. The concentration of alkali metal ions in the supercritical solvent is adjusted so as to ensure the specified 15 solubilities of feedstock or nitride, and the molar ratio of the alkali metal ions to other components of the resultant supercritical solution is controlled within a range from 1 : 200 to 1 : 2, preferably from 1 : 100 to 1 : 5, more preferably from 1 : 20 to 1 : 8. In case of using 20 the combination of two or more elements of alkali metal ions, the rate of crystal growth and crystal quality can be improved more, compared with the case where only one element of alkali metal ion is used. Moreover an alkaline earth metal, such as Mg, Zn or Cd, can be simultaneously 25 used, as required. Furthermore, neutral element (alkali

metal halide), acidic element (ammonium halide) may be simultaneously used, in so far as the ammono-basic supercritical reaction is not hindered.

(Dissolution of feedstock)

5 Dissolution of feedstock is a reversible or irreversible process where the feedstock is in the form of nitride compounds soluble in the supercritical solvent, for example gallium complex compound or aluminum complex compound. Gallium complex compound is a chemical complex compound, in which a centrally placed gallium atom is surrounded by NH₃ type ligands or their derivatives, such 10 as NH₂⁻, NH²⁻.

(Supercritical ammonia-containing solution)

The term "supercritical ammonia-containing solution" 15 means a soluble gallium or aluminum compounds formed by the dissolution of the feedstock in the supercritical ammonia-containing solvent. Based on our experiments, we have found that there is an equilibrium relationship between the metallic nitride solid and the supercritical solution under 20 sufficiently high temperature and pressure conditions. Accordingly, the solubility of the soluble nitride can be defined as the equilibrium concentration of the above soluble gallium or aluminum compounds in the presence of solid nitride. In such a process, it is possible to shift 25 this equilibrium by changing temperature and/or pressure.

(Solubility)

The phrase "negative temperature coefficient of solubility" means that the solubility is expressed by a monotonically decreasing function of the temperature, when all other parameters are kept constant. Similarly, the phrase "positive pressure coefficient of solubility" means that the solubility is expressed by a monotonically increasing function of the pressure, when all other parameters are kept constant. Based on our research, the solubility of nitride in the supercritical ammonia-containing solvent has a negative temperature coefficient within a range of 300 to 550°C, and a positive pressure coefficient within the range of 1 to 5.5 kbar, respectively.

For example, as shown in Fig. 2, after dissolution of feedstock in an autoclave kept for 8 days at the temperature 400°C (i.e. after dissolution step), crystallization of gallium nitride may be achieved by increasing the temperature inside the autoclave to 500°C (crystallization step). On the other hand, as shown in Fig. 3, after dissolution of a feedstock at increased pressure in an autoclave kept for 2 days at the level of 3.5 kbar (i.e. after dissolution step), crystallization of gallium nitride is achieved by means of reducing the pressure to 2 kbar in the autoclave (crystallization step).

25 (Supersaturation)

The phrase "supersaturation of the supercritical ammonia-containing solution with respect to the nitride" means that the concentration of the soluble gallium or aluminum compounds in the supercritical ammonia-containing solution is higher than the concentration in the equilibrium state, i.e., the solubility of nitride. In case of the dissolution of nitride in a closed system, such supersaturation can be achieved, according to the negative temperature coefficient or the positive pressure coefficient of solubility, by raising the temperature or reducing the pressure.

(Chemical transport)

The phrase "the chemical transport of nitride in the supercritical ammonia-containing solution" means a sequential process including the dissolution of the feedstock, the transfer of the soluble nitride through the supercritical ammonia-containing solution, and the crystallization of nitride from the supersaturated supercritical ammonia-containing solution. In general, a chemical transport process is carried out by a certain driving force such as a temperature gradient, a pressure gradient, a concentration gradient, difference in chemical or physical properties between the dissolved feedstock and the crystallized product, or the like. Preferably, the chemical transport in the process of the present invention

is achieved by carrying out the dissolution step and the crystallization step in separate zones, provided that the temperature of the crystallization zone is maintained higher than that of the dissolution zone so that the
5 nitride bulk single crystal can be obtained by the processes of this invention.

(Seed)

The term "seed" has been described by way of examples in the present specification. The seed provides a region
10 or area on which the crystallization of nitride is allowed to take place and the growth quality of the crystal depends on the quality of the seed. Thus, the seed of a high quality should be selected. The dislocation density thereof is preferably $10^5/\text{cm}^2$ or less. As a seed, a natural seed
15 obtained by flux method or high pressure method, A-plane, M-plane or R-plane seed obtained from bulk single crystal can also be used. Moreover, a seed having a seed surface exhibiting n-type electrical conductivity doped with Si may be used. Such seed can be produced using processes for
20 nitride crystal growth from gaseous phase, such as HVPE or MOCVD, etc. Doping with Si during the growth process at the level of 10^{16} to $10^{21}/\text{cm}^2$ ensures n-type electric conductivity. Moreover, a composite seed may be used which obtained by depositing a separate phosphor layer on one
25 side of AlN or GaN substrate and a seed on the other side

thereof. This can be used when the plural phosphor layers are required.

(Spontaneous crystallization)

The term "spontaneous crystallization" means an undesirable phenomenon in which the formation and the growth of the core of nitride from the supersaturated supercritical ammonia-containing solution occur at any site inside the autoclave, and the spontaneous crystallization also includes disoriented growth of the crystal on the surface of the seed.

(Light Emitting Device)

The light emitting device deposited on the phosphor substrate may have a homogeneous structure or a heterogeneous structure or double heterogeneous structure, such as MIS joint, PIN joint or pn joint. Various luminescence wavelength can be selected in accordance with the element of the semiconductor layer and the mixture ratio of crystal. The semiconductor active layer may have a single quantum well structure or multiple quantum well structure formed on a thin film which enhances the quantum effect, so that the output power thereof can be improved. Regarding the light emitting device used in the present invention, a semiconductor light emitting device is preferred having a light emitting layer being able to emit the light emitting wavelength which can make it possible to

excite the phosphor substrate effectively. According to the present invention, the emitted light converted in the phosphor substrate can be obtained with the constant wavelength under the condition where the light emitting wavelength region of the light emitting layer is set within the ultraviolet region, even if there are some errors of the light emitting wavelength in the light emitting layer. Furthermore, the emitted light from the phosphor substrate can be mixed with a part of the light emitted from the other phosphor, so that the white light can be emitted.

10 (Other phosphor)

The "other phosphor" is selected so as to form the preferred white light source by complementing with a phosphor substrate without limitation such as powder form or substrate. For example, the nitride phosphor can contain (1) N and (2) at least one element of Group II selected from the group consisting of Be, Mg, Ca, Sr, Ba and Zn (which is activated by at least one element of rare earth selected from the group consisting of Y, La, Ce, Pr, Nd, Sm, Eu, Gd, Tb, Dy, Ho, Er and Lu) and (3) at least one element of Group IV selected from the group consisting of C, Si, Ge, Sn, Ti, Zr and Hf.

20 (Selective crystallization)

The term "selective crystallization on the seed" means a step of allowing the crystallization to take place on the

surface of the seed, accompanied by substantially no spontaneous growth. This selective crystallization on the seed is essential for the growth of a bulk single crystal, and it is one of the elements of the present invention.

5 (Feedstock)

Pellets to be used in the present invention are prepared by molding the powder and baking them so that their density is 70 % or more. Higher density is preferable. The powder once formed can be used. Or it is possible to apply a method comprising the steps of forming the poly crystal of the metallic nitride from metal, dissolving and recrystallizing the same in the crucible placed in the dissolution zone in the supercritical ammonia-containing solution, for example, similarly as the method of forming gallium nitride from metallic gallium.

(Temperature and pressure of the reaction)

The temperature distribution in the autoclave as will be described later in the part of Example is determined by using an empty autoclave, i.e. without the supercritical ammonia, and thus, the supercritical temperature is not the one actually measured. On the other hand, the pressure in the autoclave is directly measured, or it is determined by the calculation from the amount of ammonia introduced initially, the temperature and the volume of the autoclave.

25 (Example)

High-pressure autoclave 1 (Fig. 4 and 5), having the inner diameter of 40mm, length equal to 480 mm ($D/L=1/12$) and volume of 585cm^3 , is charged with 30g of feedstock in the form of GaN in the crucible in the dissolution zone 13, 5 and GaN seed of the diameter of 1 inch Φ obtained by HVPE method is placed in the crystallization zone 14 of the same autoclave. Next the autoclave 1 is filled with 1.2g of 6N purity metallic gallium and 1.2g of metallic Zn, and then 10 7g of 3N purity metallic lithium (or 23g of metallic sodium) as a mineralizer, and further 238g of ammonia (5N) and finally closed. The autoclave 1 is introduced into the furnace unit 4 and heated to 200°C for three days.

Then the temperature in the dissolution zone 13 of the autoclave is increased to 425°C , while the temperature in 15 the crystallization zone 14 is increased to 525°C . The resultant pressure within the autoclave is 2.5 kbar. The autoclave is left under such condition for another twenty eight days. (Fig. 6) As a result of the processes, partial dissolution of the feedstock in the dissolution zone 13 and 20 growth of GaN:Zn on the HVPE-GaN seed in the crystallization zone 14 are observed.

The processes described below are carried out so as to use the resultant crystal as a substrate.

1) A single crystal deposited on a HVPE-GaN seed is 25 put into a furnace and annealed for 1 to 5 hours in the

nitrogen atmosphere, containing low amount of oxygen, at temperature from 600°C to 900°C.

2) The sample is placed into the wire saw manufactured by Takatori Corp. The sample is positioned with the off-angle about 1 degree or less. Then the sample is sliced by diamond slurry, so that the sample with the off-angle between 0.05 and 0.2 degree is obtained.

3) The sliced samples are put once more into a furnace and annealed again for 1 to 5 hours in the nitrogen atmosphere, containing low amount of oxygen, at temperature from 600°C to 900°C. (The thus prepared sample is called GaN:Zn phosphor substrate.)

4) The GaN:Zn phosphor substrate is adhered by adhesive agent on the block for polishing, the block is placed on a polishing machine manufactured by Logitech Ltd. and the GaN substrate is polished consecutively on each side. In the polishing process, diamond slurry and colloidal silica with pH from 3 to 6 or alumina solution with pH from 9 to 11 are used. The roughness of the obtained surface is 10Å or less.

5) Next, a cap layer of less than several μm in the form of GaN or AlGaN is formed on the surface of GaN substrate by HVPE method, under the condition as follows, so that a template is obtained.

HVPE condition: reaction temperature: 1050°C,

reaction pressure: atmospheric pressure,
partial pressure of ammonia: 0.3atm,
partial pressure of GaCl: 1×10^{-3} atm
hydrogen carrier gas

5 As required, 6) After polishing, the substrate is kept in the supercritical ammonia without mineralizer for 1 day at 200°C and then the impurity on the surface of the substrate is removed.

10 The obtained phosphor substrate is illuminated with the UV rays of the wavelength of 365 nm, followed by measuring its luminescence spectrum. The peak of the wavelength is within 400-480 nm.

15 (7) Then, the LED device of UV rays is deposited on the phosphor substrate 101. The condition of the nitride semiconductor 102 is described below.

An undoped GaN layer of 5 μm , an n-type clad layer of 400 angstroms $\text{Al}_{0.18}\text{Ga}_{0.82}\text{N}$ doped with Si (dopant of Si: $5 \times 10^{17}/\text{cm}^3$), and an active layer having total thickness of 420 angstroms comprised with $\text{Al}_{0.1}\text{Ga}_{0.9}\text{N}$ of 200 angstroms 20 doped with Si / $\text{In}_{0.03}\text{Al}_{0.02}\text{Ga}_{0.95}\text{N}$ of 70 angstroms / $\text{Al}_{0.1}\text{Ga}_{0.9}\text{N}$ of 40 angstroms doped with Si / $\text{In}_{0.03}\text{Al}_{0.02}\text{Ga}_{0.95}\text{N}$ of 70 angstroms / $\text{Al}_{0.1}\text{Ga}_{0.9}\text{N}$ of 40 angstroms doped with Si. Next, p-type clad layer comprising 600 angstroms $\text{Al}_{0.2}\text{Ga}_{0.8}\text{N}$ doped with Mg, p-type contact layer of 0.1 μm $\text{Al}_{0.04}\text{Ga}_{0.96}\text{N}$ doped 25 with Mg (dopant of Mg: $1 \times 10^{19}/\text{cm}^3$), and a layer of 0.02 μm

$\text{Al}_{0.01}\text{Ga}_{0.99}\text{N}$ doped with Mg (dopant of $\text{Mg}:2 \times 10^{21}/\text{cm}^3$) is formed.

In the obtained LED device (Fig.11), an n-type electrode and a p-type electrode are formed on the same side. The LED device performs UV rays light emitting: 373 nm, power output: 4.2 mW and Vf:3.5V in the current forward direction of 20 mA. Moreover, the wavelength is converted by a phosphor substrate so as to obtain the light emitting device with 460 nm. The light emitting device is preferably in the form of flip chip type having the light extraction plane on the side of the phosphor substrate.

According to the present invention, the spectral reflectance of the phosphor is high and the absorption coefficient is low, so that the light can be emitted effectively.

(Example 2)

The light emitting device obtained in Example 1 is made in the form of flip chip type, then the light emitting device having the other phosphor is formed. The other phosphor can be formed by coating the surface of the light extraction plane of the phosphor substrate or by molding the resin mixed with phosphor. According to this Example, light emitting device (101, 102) is made in the form of flip chip type and nitride phosphor layer 103 of $(\text{Ca}_{0.97}\text{Eu}_{0.03})_2\text{Si}_5\text{N}_8$ is coated by spray coating or screen

print on the surface of the light extraction plane of the phosphor substrate of the light emitting device so as to obtain a white light resource. (Fig.12)

(Example 3)

5 The light emitting device obtained in Example 1 is made in the form of flip chip type using the yttrium-gadolinium-aluminum oxide phosphor activated by Cerium (Y-Gd-Al-O:Ce) as a phosphor coating the surface of the substrate of the light emitting device by spray coaring or
10 screen print so as to obtain a white light resource.

(Example 4)

In the light emitting device obtained in Example 1, the surface of the substrate of the light emitting device is coated with a nitride phosphor of $\text{Ca}_2\text{Si}_5\text{N}_7:\text{Eu}$ with
15 addition of B, so as to obtain a white light resource.

(Example 5)

In the light emitting device obtained in Example 1, the surface of the substrate of the light emitting device is coated with $(\text{Ca}_{0.97}\text{Eu}_{0.03})_2\text{Si}_5\text{N}_8$ and yttrium-gadolinium-aluminum oxide phosphor activated by Cerium (Y-Gd-Al-O:Ce)
20 so as to obtain a white light resource.

Industrial Applicability

A high quality nitride phosphor substrate can be
25 manufactured by crystallization from supercritical ammonia-

containing solution, so that the light emitting device comprising the substrate can be obtained.